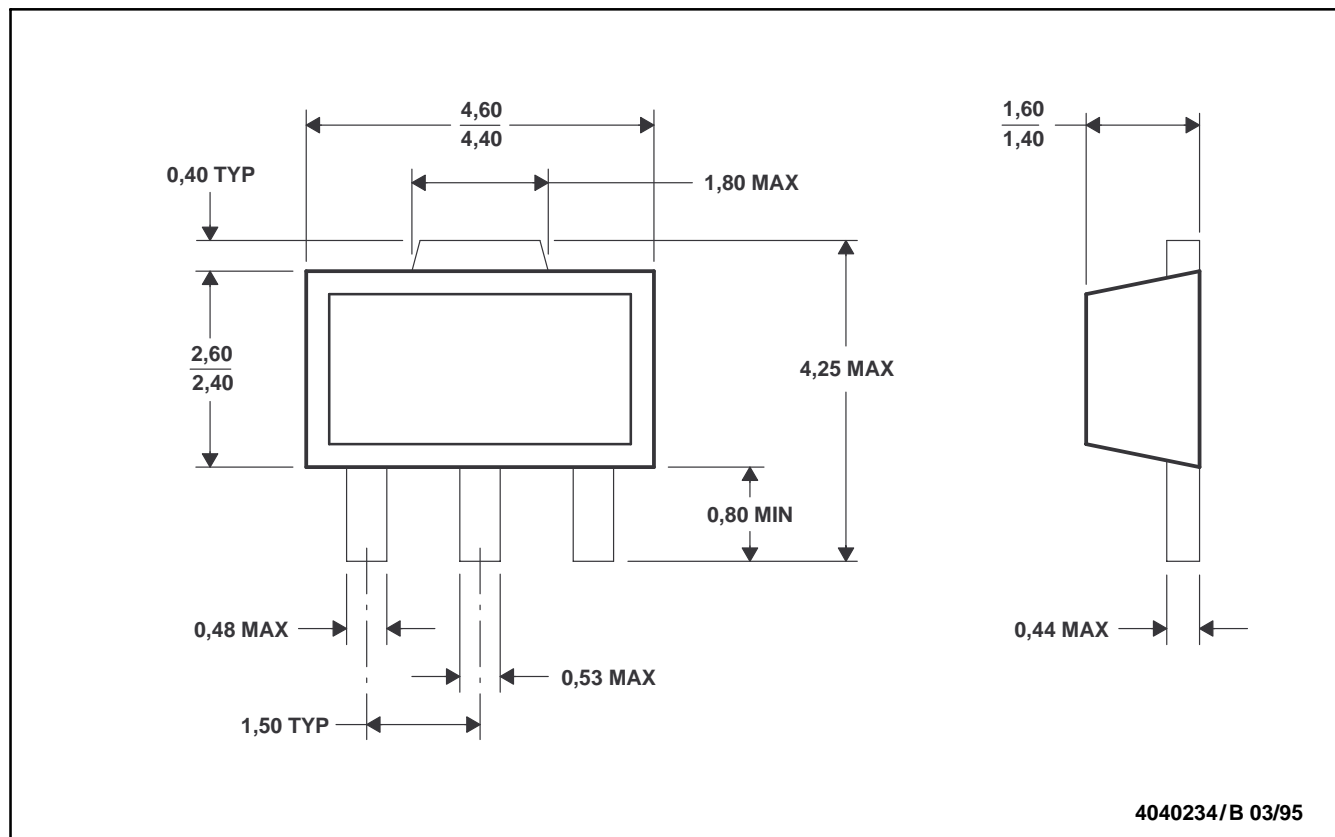


PK (R-PSSO-F3)

PLASTIC SINGLE-IN-LINE PACKAGE



- NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. The center lead is in electrical contact with the tab.

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